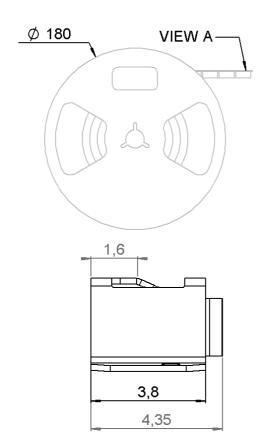
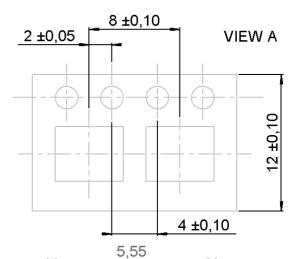
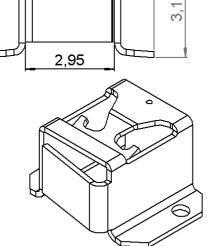
R107.303.040

Series: UMP











All dimensions are in mm.

			— — — —	
_	COMPONENTS	MATERIALS	PLATINGS (μm)	
	BODY CENTER CONTACT OUTER CONTACT INSULATOR GASKET OTHERS PARTS	BERYLLIUM COPPER	GOLD 0.2 OVER NICKEL 2	

Issue: 1213 C

In the effort to improve our products, we reserve the right to make changes judged to be necessary.



BOBINE 100

R107.303.040

Series: UMP

PACKAGING

Standard	Unit	Other
100	'W' option	Contact us

SPECIFICATION

ELECTRICAL CHARACTERISTICS

 $\begin{array}{ccc} \text{Impedance} & & \textbf{50} \;\; \Omega \\ \text{Frequency} & & \textbf{0-6} \;\; \text{GHz} \end{array}$

VSWR 1.05 + 0,0300 x F(GHz) Maxi

Insertion loss $NA \sqrt{F(GHz)} MAxi$

RF leakage - (NA - F(GHz)) dB Maxi Voltage rating 100 Veff Maxi

Dielectric withstanding voltage Insulation resistance $1000 \text{ M}\Omega$ mini

ENVIRONMENTAL

Operating temperature -40/+125 ° C

Hermetic seal NA Atm.cm3/s

Panel leakage NA

OTHERS CHARACTERISTICS

Assembly instruction

Others:

MECHANICAL CHARACTERISTICS

Center contact retention

Axial force – Mating end
Axial force – Opposite end
Torque

- N mini
- N.cm mini

Recommended torque

Mating - N.cm Panel nut - N.cm

Mating life 50 Cycles mini

Weight **0,0600** g

Issue: 1213 C

In the effort to improve our products, we reserve the right to make changes judged to be necessary.

RADIALL[®]

R107.303.040

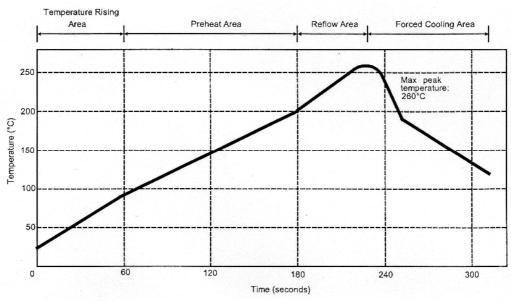
Series: UMP

SOLDER PROCEDURE OF UMP RECEPTABLE IN INDUSTRIAL ENVIRONMENT

- 1. Deposit solder paste 'Sn Ag4 Cu0.5' on mounting zone by screen printing application. We recommend a low residue flux.
 - We advise a thickness of 150 micromm (5.850 microinch). Verify that the edges of the zone are clean.
- 2. Placement of the receptacle on the mounting zone with an automatic machine of 'pick and place' type. A video camera is recommended for positioning of the component. Adhesive agents must not be used on the receptacle.
- 3. This process of soldering has been tested with convection oven .Below please find ,the typical profile to use.
- 4. The cleaning of printed circuit boards is not obliged.
- 5. Verification of solder joints and position of the component by visual inspection.

NOTE: The UMP receptacle and the UMP plug must not be mated before completion of this procedure

TEMPERATURE PROFILE



Parameter	Value	Unit
Temperature rising Area	1 - 4	°C/sec
Max Peak Temperature	260	°C
Max dwell time @260°C	10	sec
Min dwell time @235°C	20	sec
Max dwell time @235°C	60	sec
Temperature drop in cooling Area	-1 to -4	°C/sec
Max dwell time above 100°C	420	sec

Issue: 1213 C In the effort to improve our products, we reserve the right to make changes judged to be necessary.



R107.303.040

BOBINE 100

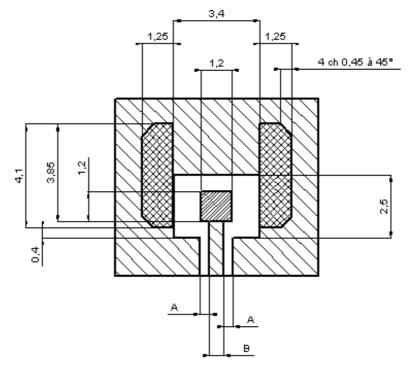
Series: UMP

UMP SERIES INFORMATION

PCB

COPLANAR LINE

Ground and signal are on the same side The material of PCB is glass is glass-epoxy Composite.



Sold over nickel for solder paste

Gold over nickel contact area free of any surface contaminant

Ground + varnish

APPLICATION 75 Ω WITH B = 0.55mm

PCB thickness (mm)	Coplanar ligne A (mm)			
0,8	0,57			
1,0	0,45			
1,2	0,41			
1,6	0,37			

APPILCATION 50Ω WITH B = 1,2mm

PCB thickness (mm)	Coplanar ligne A (mm)
0,8	0,183
1,0	0,190
1,2	0,195
1,6	0,20

Issue: 1213 C

In the effort to improve our products, we reserve the right to make changes judged to be

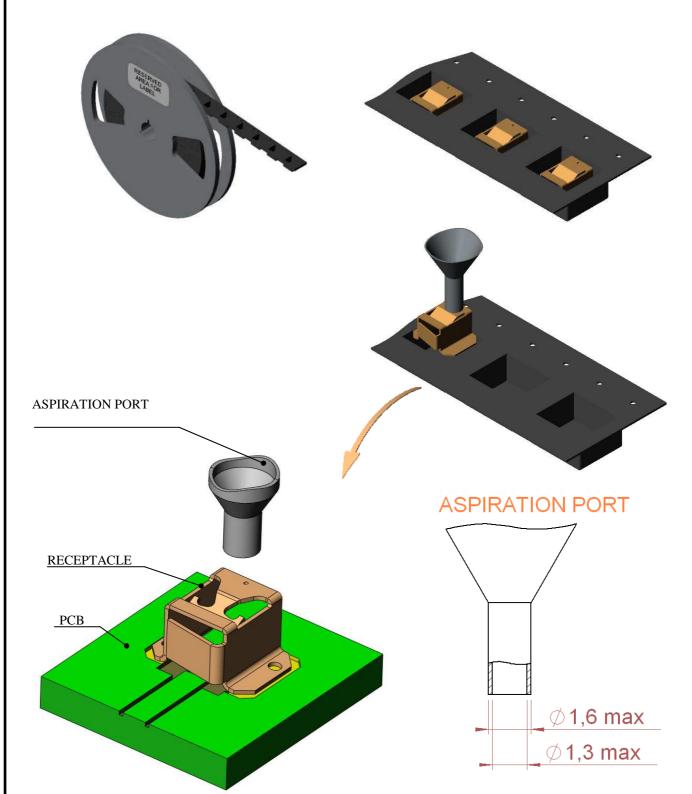


BOBINE 100

R107.303.040

Series: UMP

UMP SERIES INFORMATION



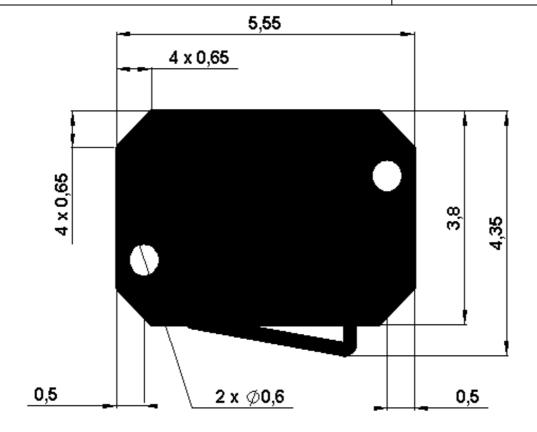
Issue: 1213 C In the effort to improve our products, we reserve the right to make changes judged to be necessary.



BOBINE 100

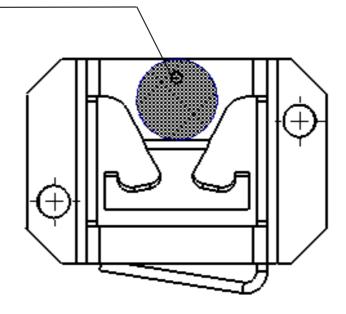
R107.303.040

Series: UMP



SHADOW FOR VIDEO CAMERA

ASPIRATION AREA



Issue: 1213 C In the effort to improve our products, we reserve the right to make changes judged to be necessary.

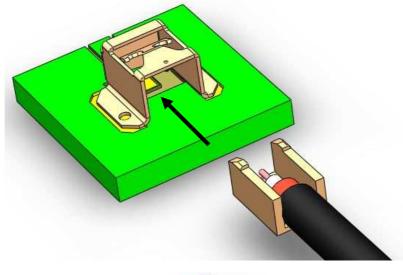


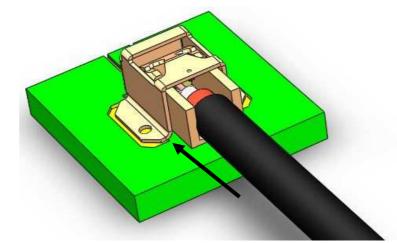
BOBINE 100

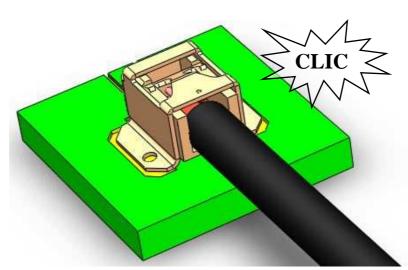
R107.303.040

Series: UMP

UMP CONNECTING NOTE







Issue: 1213 C
In the effort to improve our products, we reserve the right to make changes judged to be necessary

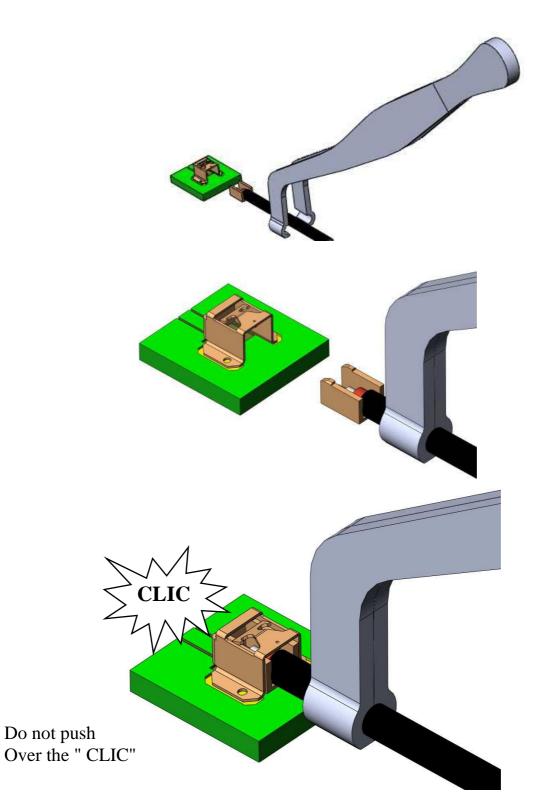


R107.303.040

BOBINE 100

Series: UMP

UMP CONNECTING NOTE



Issue: 1213 C

In the effort to improve our products, we reserve the right to make changes judged to be

necessary.

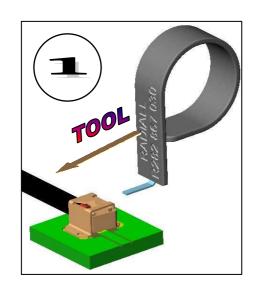


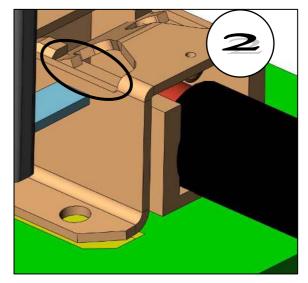
BOBINE 100

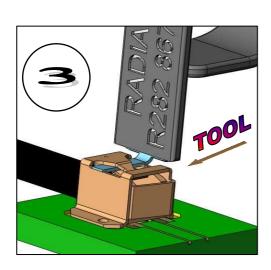
R107.303.040

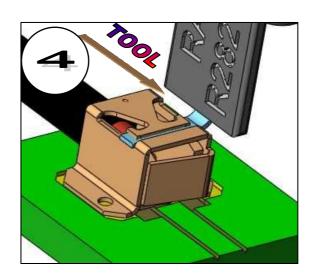
Series: UMP

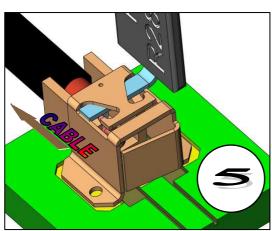
UMP DISCONNECTING NOTE

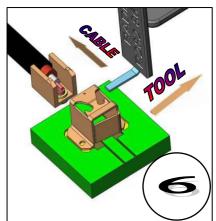












Issue: 1213 C In the effort to improve our products, we reserve the right to make changes judged to be necessary.

